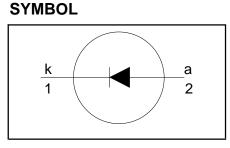
# **BYC10-600**

# **FEATURES**

- Extremely fast switching
- · Low reverse recovery current
- Low thermal resistance

Reduces switching losses in associated MOSFET



### **APPLICATIONS**

- Active power factor correction
- Half-bridge lighting ballasts
  Half-bridge/ full-bridge switched mode power supplies.

The BYC10-600 is supplied in the SOD59 (TO220AC) conventional leaded package.

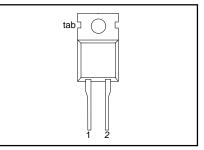
	-	
PIN	DESCRIPTION	
1	cathode	
2	anode	
tab	cathode	

#### **QUICK REFERENCE DATA**

# $V_{R} = 600 V$ $V_F \le 1.8 \text{ V}$ $I_{F(AV)} = 10 \text{ A}$

 $t_{rr} = 19 \text{ ns} (typ)$ 

# **SOD59 (TO220AC)**



### LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

PINNING

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>RRM</sub>	Peak repetitive reverse voltage		-	600	V
V <sub>RWM</sub>	Crest working reverse voltage		-	600	V
V <sub>R</sub>	Continuous reverse voltage	T <sub>mb</sub> ≤ 114 °C	-	500	V
I <sub>F(AV)</sub>	Average forward current	$\delta = 0.5$ ; with reapplied V <sub>RRM(max)</sub> ; T <sub>mb</sub> $\leq$ 78 °C	-	10	A
I <sub>FRM</sub>	Repetitive peak forward current	δ = 0.5; with reapplied V <sub>RRM(max)</sub> ; T <sub>mb</sub> ≤ 78 °C	-	20	A
I <sub>FSM</sub>	Non-repetitive peak forward	t = 10 ms	-	65	A
	current.	t = 8.3 ms sinusoidal; $T_j = 150^{\circ}C$ prior to surge with reapplied $V_{RWM(max)}$	-	71	A
T <sub>stg</sub> T <sub>i</sub>	Storage temperature Operating junction temperature	With reapplied V <sub>RWM(max)</sub>	-40 -	150 150	°C C

#### THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R <sub>th j-mb</sub>	Thermal resistance junction to mounting base		-	-	2	K/W
R <sub>th j-a</sub>		in free air.	-	60	-	K/W

#### ELECTRICAL CHARACTERISTICS

 $T_i = 25$  °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>F</sub>	Forward voltage	I <sub>F</sub> = 10 A; T <sub>i</sub> = 150°C I <sub>F</sub> = 20 A; T <sub>i</sub> = 150°C	-	1.4	1.8	V
		$I_F = 20 \text{ A}; I_j = 150 \text{ C}$ $I_F = 10 \text{ A};$	-	1.7 2.0	2.3 2.9	
I <sub>R</sub>	Reverse current	$\dot{V}_{R} = 600 V$	-	9	200	μÂ
		V <sub>R</sub> = 500 V; T <sub>j</sub> = 100 °C	-	1.1	3.0	mA
t <sub>rr</sub>	Reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 50 \text{ A/}\mu\text{s}$	-	35	55	ns
t <sub>rr</sub>	Reverse recovery time	$I_{F} = 10 \text{ Å}; V_{R} = 400 \text{ V};$ $dI_{F}/dt = 500 \text{ A}/\mu\text{s}$	-	19	-	ns
t <sub>rr</sub>	Reverse recovery time	$I_{\rm F} = 10 \text{ A}; V_{\rm R} = 400 \text{ V};$	-	32	40	ns
		$dI_{F}/dt = 500 \text{ A}/\mu \text{s}; T_{j} = 100^{\circ}\text{C}$				
I <sub>rrm</sub>	Peak reverse recovery current	$I_{\rm F} = 10 \text{ A}; V_{\rm R} = 400 \text{ V};$	-	3	7.5	А
I <sub>rrm</sub>	Peak reverse recovery current	dI <sub>F</sub> /dt = 100 A/μs; T <sub>i</sub> = 125°C I <sub>F</sub> = 10 A; V <sub>R</sub> = 400 V;	-	9.5	12	А
		$dI_{F}/dt = 500 \text{ A}/\mu \text{s}; T_{j} = 125 ^{\circ}\text{C}$				
V <sub>fr</sub>	Forward recovery voltage	I <sub>F</sub> = 10 A; dI <sub>F</sub> /dt = 100 A/μs	-	8	11	V

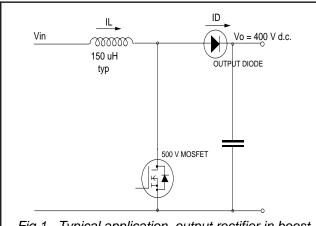
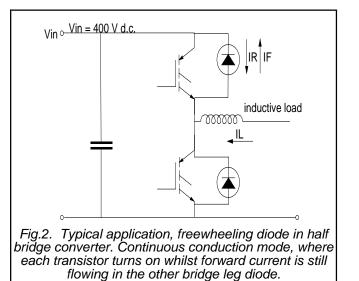
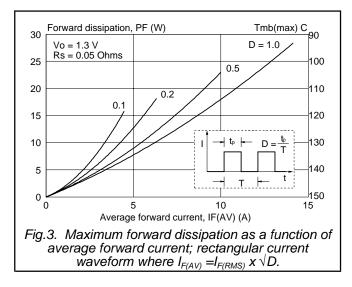


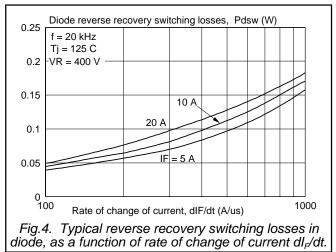
Fig.1. Typical application, output rectifier in boost converter power factor correction circuit. Continuous conduction, mode where the transistor turns on whilst forward current is still flowing in the diode.

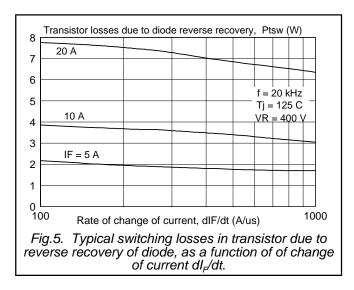


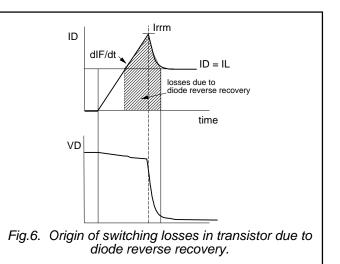
# BYC10-600

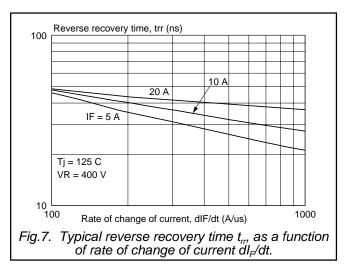
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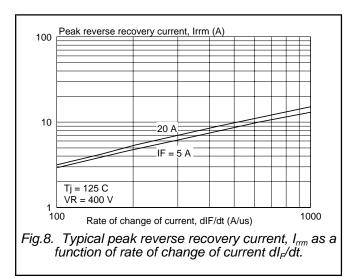




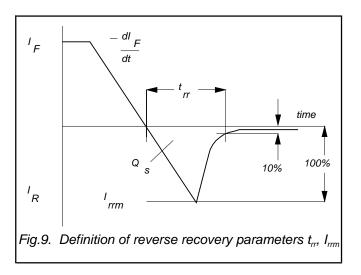


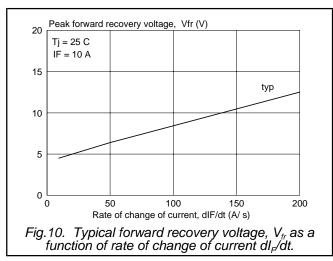


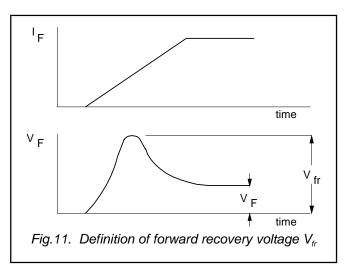


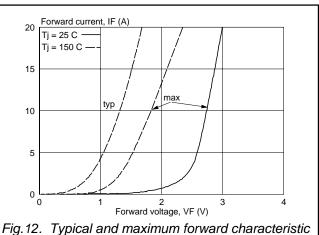


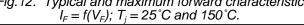
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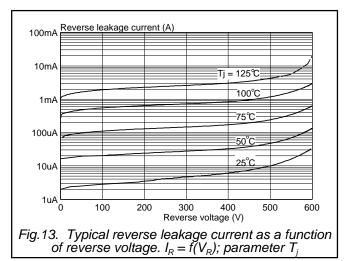


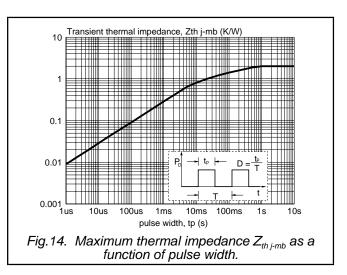






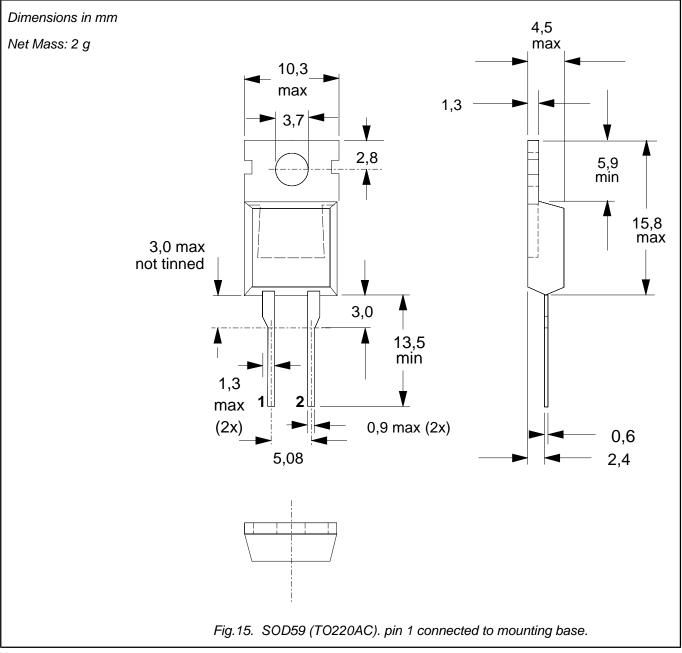






# BYC10-600

#### **MECHANICAL DATA**



**Notes** 1. Refer to mounting instructions for TO220 envelopes. 2. Epoxy meets UL94 V0 at 1/8".

BYC10-600

# DEFINITIONS

Data sheet status			
Objective specification	bjective specification This data sheet contains target or goal specifications for product development.		
Preliminary specification This data sheet contains preliminary data; supplementary data may be published la			
Product specification	This data sheet contains final product specifications.		
Limiting values			
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.			
Application information			
Where application information is given, it is advisory and does not form part of the specification.			
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